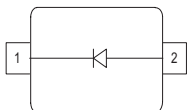
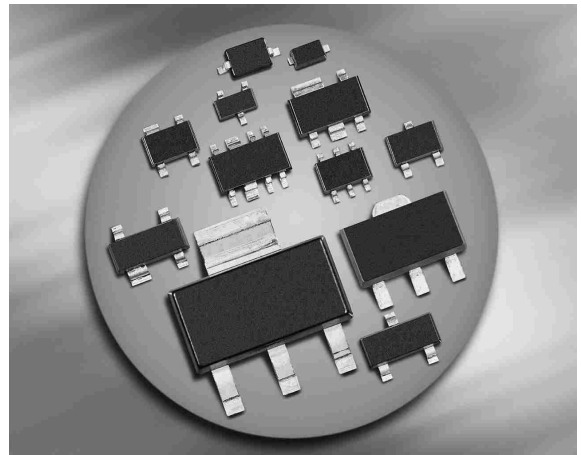


Silicon Tuning Diode

- Excellent linearity
- Low series resistance
- Designed for low tuning voltage operation for VCO's in mobile communications equipment
- Very low capacitance spread
- Pb-free (RoHS compliant) package



BBY56-02V
BBY56-02W
BBY56-03W



Type	Package	Configuration	Marking
BBY56-02V	SC79	single	9
BBY56-02W*	SCD80	single	66
BBY56-03W	SOD323	single	red 6

* Not for new design

Maximum Ratings at $T_A = 25\text{ °C}$, unless otherwise specified

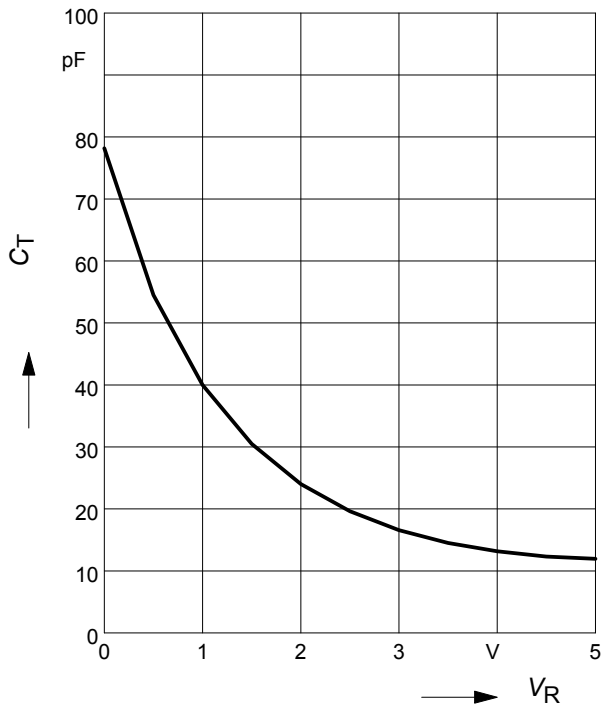
Parameter	Symbol	Value	Unit
Diode reverse voltage	V_R	10	V
Forward current	I_F	20	mA
Operating temperature range	T_{op}	-55 ... 150	°C
Storage temperature	T_{Stg}	-55 ... 150	

Electrical Characteristics at $T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Reverse current	I_R				nA
$V_R = 6\text{ V}$		-	-	5	
$V_R = 6\text{ V}, T_A = 85\text{ }^{\circ}\text{C}$		-	-	100	
AC Characteristics					
Diode capacitance	C_T				pF
$V_R = 1\text{ V}, f = 1\text{ MHz}$		37	40	43	
$V_R = 2\text{ V}, f = 1\text{ MHz}$		22	-	25	
$V_R = 3\text{ V}, f = 1\text{ MHz}$		14.8	15.8	16.8	
$V_R = 4\text{ V}, f = 1\text{ MHz}$		-	12.1	-	
Capacitance ratio	C_{T1}/C_{T3}				
$V_R = 1\text{ V}, V_R = 3\text{ V}, f = 1\text{ MHz}$		2.15	2.53	-	
$V_R = 1\text{ V}, V_R = 4\text{ V}, f = 1\text{ MHz}$		-	3.3	-	
Series resistance	r_S	-	0.25	-	Ω
$V_R = 1\text{ V}, f = 470\text{ MHz}$					

Diode capacitance $C_T = f(V_R)$

$f = 1\text{ MHz}$



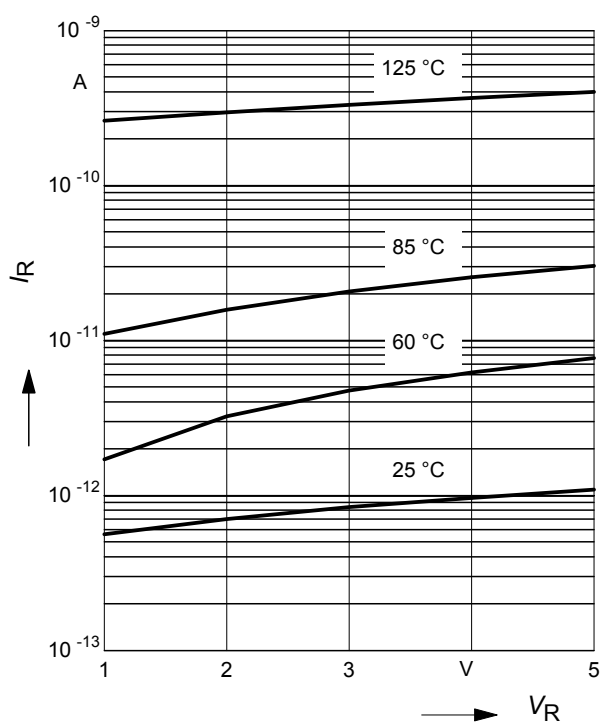
Temperature coefficient of the diode capacitance $T_{Cc} = f(V_R)$

$f = 1\text{ MHz}$

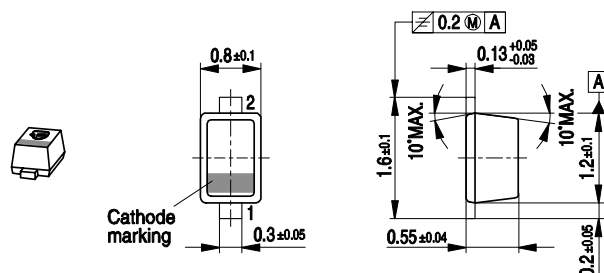


Reverse current $I_R = f(V_R)$

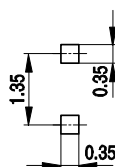
$T_A = \text{Parameter}$



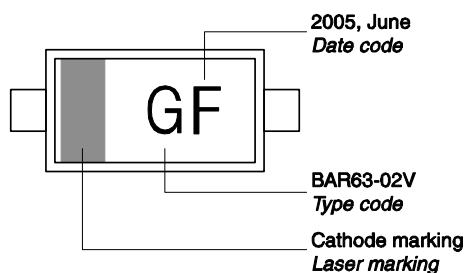
Package Outline



Foot Print

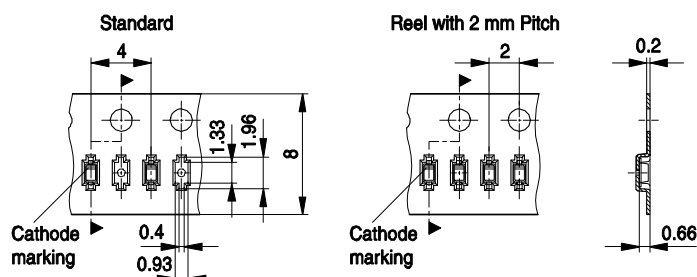


Marking Layout (Example)

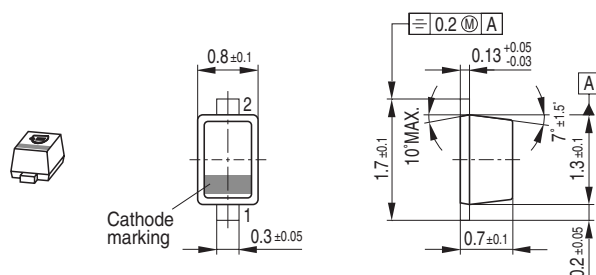


Standard Packing

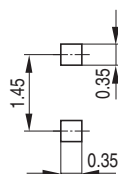
Reel ø180 mm = 3.000 Pieces/Reel
 Reel ø180 mm = 8.000 Pieces/Reel (2 mm Pitch)
 Reel ø330 mm = 10.000 Pieces/Reel



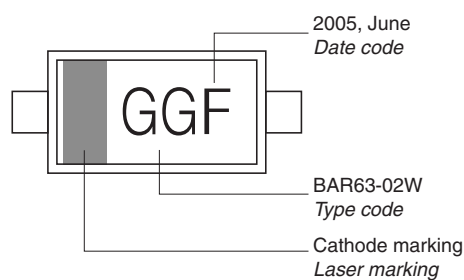
Package Outline



Foot Print

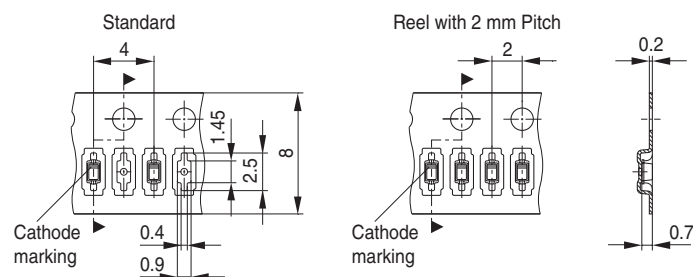


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel
 Reel ø180 mm = 8.000 Pieces/Reel (2 mm Pitch)
 Reel ø330 mm = 10.000 Pieces/Reel

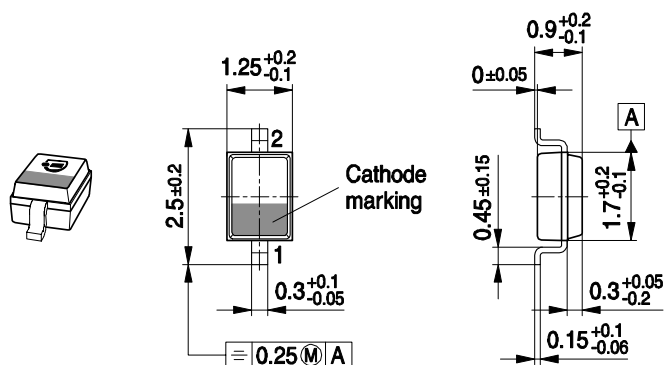


Date Code marking for discrete packages with one digit (SCD80, SC79, SC75¹⁾) CES-Code

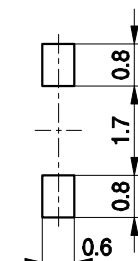
Month	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014
01	a	p	A	P	a	p	A	P	a	p	A	P
02	b	q	B	Q	b	q	B	Q	b	q	B	Q
03	c	r	C	R	c	r	C	R	c	r	C	R
04	d	s	D	S	d	s	D	S	d	s	D	S
05	e	t	E	T	e	t	E	T	e	t	E	T
06	f	u	F	U	f	u	F	U	f	u	F	U
07	g	v	G	V	g	v	G	V	g	v	G	V
08	h	x	H	X	h	x	H	X	h	x	H	X
09	j	y	J	Y	j	y	J	Y	j	y	J	Y
10	k	z	K	Z	k	z	K	Z	k	z	K	Z
11	l	2	L	4	l	2	L	4	l	2	L	4
12	n	3	N	5	n	3	N	5	n	3	N	5

1) New Marking Layout for SC75, implemented at October 2005.

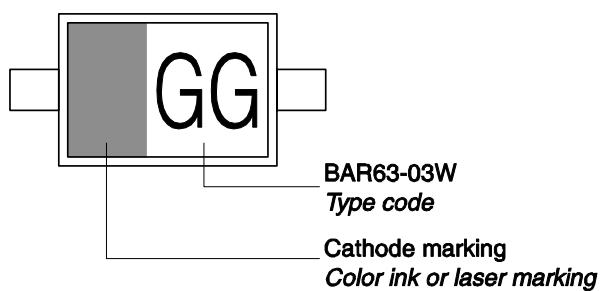
Package Outline



Foot Print

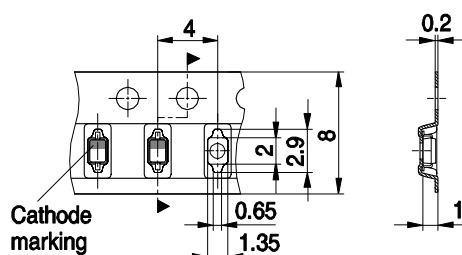


Marking Layout (Example)



Standard Packing

Reel $\varnothing 180 \text{ mm}$ = 3.000 Pieces/Reel
 Reel $\varnothing 330 \text{ mm}$ = 10.000 Pieces/Reel



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